

KOREATECH Summer Program for Capstone Design Project

: Renewable Energy for Enhancing our Life Quality

From July 15th to August 9th (4weeks & 3 Credits)

Capstone Design Project

Renewable energy for enhancing our life quality

Our capstone design project focuses on the understanding of key concepts in **design, manufacturing and the application of solar cells and 3D modeling which covers both the theoretical and experimental aspects.**

This program will enhance participant's Communication, Cooperation, Creativity and Problem Solving skills by teaming up with people of diverse nationalities and cultural backgrounds.

- Students recommended by the International Office from KOREATECH's partner universities are eligible to apply for the program
- Applicant's study field have to be in engineering field and Applicants need to be proficient English as all the programs will be provided in English.

Program fees

Application fee	USD 100
Tuition fee (experiment material and extra activities)	USD 2,000
Accommodation for 4wees	USD 300

- ※ For students recommended by KOREATECH's partner universities, program fee(registration, tuition and accommodation fees) are waived based on the student exchange agreement.
- ※ Students should buy a meal plan in students' cafeteria during the program.

Program schedule (Arrival: July 12 / Departure: August 9)

	Mon	Tue	Wed	Thu	Fri
Week 1	Conversion Seminar				Field Trip
	Mon	Tue	Wed	Thu	Fri
Week 2	Conversion Seminar				Special activities
	Mon	Tue	Wed	Thu	Fri
Week 3	Conversion Seminar				Special activities
	Mon	Tue	Wed	Thu	Fri
Week4	Conversion Seminar				Departure

General Information

Medical Insurance

- It is mandatory that all participants should purchase traveler's insurance covering the entire program period.

Certificate of Completion

- A certificate of completion will be given to students who complete the whole program faithfully. Your academic performance is assessed according to assignments, attendance and classroom participation. For participants, over 80% of class attendance is required to get the certificate along with 3 credits.

Airport pick-up service

- KOREATECH will provide "Group Transportation" between Incheon international airport and the campus on official arrival (July 12) and departure day (August 9). All participants should inform us of your flight schedule right after it has been booked.

Accommodation

- On-campus dormitory will be available to the program participants. Dorm rooms are western-style with twin beds, desk, bookshelves, closets, shower booth and toilet. You must bring or purchase your own blanket and pillow. WiFi is free. Cooking is not permitted in the dormitory.

Contact

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2019 Summer Program for Capstone Design Project

Name _____
(Last) _____ Given (First - Middle) _____

Gender _____ Female _____ Male

Nationality _____ **Place of Birth** _____

Date of Birth _____ (Year) _____ (Month) _____ (Date)

Mailing Address _____
(Street) _____ (City) _____

(Province) _____ (Postal Code) _____ (Country) _____

Attach
Passport-Sized
Color Photo

Telephone (Including Country Code) _____

E-mail _____

Name of Home University _____

Field of Study at Home University _____

Proficiency of the Korean Language: _____ High _____ Mid _____ Low

Proficiency of ENGLISH : _____ High _____ Mid _____ Low

APPLICATION CHECKLIST

Copy of Passport _____ Passport-Sized Color Photo Attached) _____
Certificate of Studentship _____ Official Transcripts of all classes at Home University _____

*** Medical insurance to be submitted upon arriving in KOREATECH**

STUDENT'S CERTIFICATION: I certify that above information is true and correct. I shall abide by the laws of the Republic of Korea and the regulations of KOREATECH.

Student's Signature: _____ Date: _____

INTERNATIONAL PROGRAM ADVISER'S CERTIFICATION: I nominate the above student for participation in the Summer School Program in KOREATECH.

Program Adviser's Name: _____

Signature: _____ Date: _____